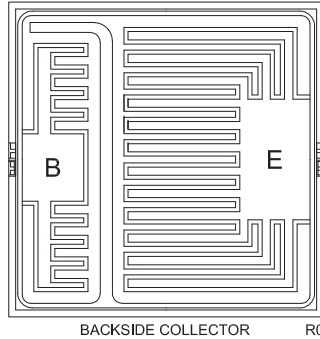


**CP527**  
**PNP - Darlington Transistor Die**  
**10 Amp, 80 Volt**

The CP527 die is a silicon PNP Darlington power transistor designed for high gain amplifier applications.



**MECHANICAL SPECIFICATIONS:**

Die Size	110 x 110 MILS
Die Thickness	10.6 MILS
Base Bonding Pad Size	21 x 24 MILS
Emitter Bonding Pad Size	24 x 42 MILS
Top Side Metalization	Al – 20,000Å
Back Side Metalization	Ni/Ag – 2,000Å/10,000Å
Scribe Alley Width	4.3 mils
Wafer Diameter	4 INCHES
Gross Die Per Wafer	700

**MAXIMUM RATINGS:** ( $T_C=25^\circ\text{C}$ )

	SYMBOL		UNITS
Collector-Base Voltage	$V_{CB0}$	80	V
Collector-Emitter Voltage	$V_{CEO}$	80	V
Emitter-Base Voltage	$V_{EBO}$	5.0	V
Continuous Collector Current	$I_C$	10	A
Operating and Storage Junction Temperature	$T_J, T_{stg}$	-65 to +200	$^\circ\text{C}$

**ELECTRICAL CHARACTERISTICS:** ( $T_A=25^\circ\text{C}$  unless otherwise noted)

SYMBOL	TEST CONDITIONS	MIN	MAX	UNITS
$I_{CEO}$	$V_{CE}=80\text{V}$		1.0	mA
$I_{EBO}$	$V_{EB}=5.0\text{V}$		10	mA
$BV_{CB0}$	$I_C=100\mu\text{A}$	80		V
$BV_{CEO}$	$I_C=3.0\text{mA}$	80		V
$BV_{EBO}$	$I_E=5.0\text{mA}$	5.0		V
$V_{CE(SAT)}$	$I_C=5.0\text{A}, I_B=10\text{mA}$		2.0	V
$V_{BE(ON)}$	$V_{CE}=3.0\text{V}, I_C=5.0\text{A}$		2.8	V
$h_{FE}$	$V_{CE}=3.0\text{V}, I_C=5.0\text{A}$	1.0K	20K	
$C_{ob}$	$V_{CB}=10\text{V}, I_E=0, f=1.0\text{MHz}$		200	pF

# CP527

## Typical Electrical Characteristics

